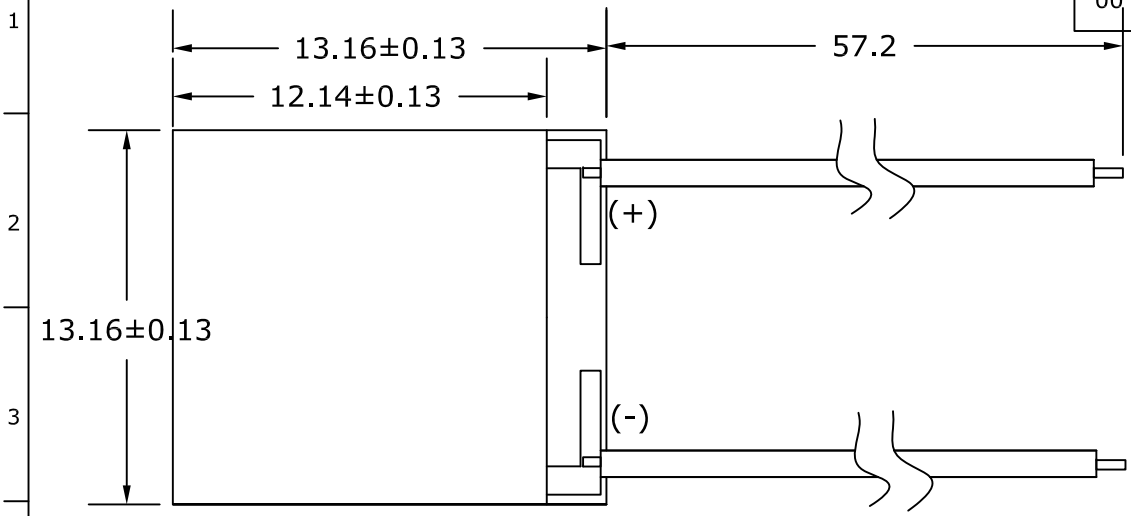
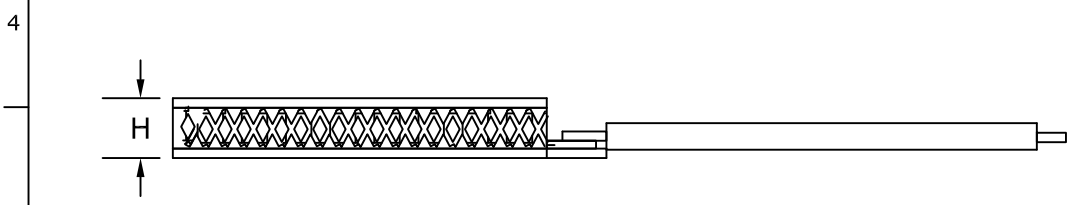


REV	BY	DATE	ECN/ERO	DESCRIPTION
00	Jinlong	09/02/17	-	PRODUCTION RELEASE



NOTES:


- ①. Wire are AWG30,1/30, Solid wire.
- 2. Lapped both side, height is 2.438±0.051mm, flatness and parallel is 0.051mm.
- ③. Non sealing around TEM.
- ④. ACR: 3.950-4.389-4.828 ohms(23°C)



REFERENCE ONLY!	
Nominal Specs (@25°C)	
I_{max} (A)	1.5
U_{max} (V)	7.8
Q_{max} (W)	6.8
ΔT_{max} (°C)	64

Ceramic Material: Alumina(Al₂O₃)
Solder Construction: 232°C SbSn

NOTE:
ALL DIMENSIONS = mm

		P/N	DESCRIPTION
		387001816	ET15,65,F2A,1312,11,W2.25
4707 DETROIT AVE CLEVELAND, OHIO 44102		PH. (216) 939-2300 FAX (216) 939-2310	
SURFACE FINISH 3.2 √μm 125 √μln (UNLESS OTHERWISE SPECIFIED) BREAK ALL EDGES; 0.015 [0.40mm] x 45°		TITLE THERMOELECTRIC MODULE 232° SbSn CONSTRUCTION	
NAME DATE DRAWN BY Jinlong 09/02/17 INITIATED BY APPROVAL		DWG NO	REV
		387001816	00